# SC728/SC729



# 2A Low Vin, Very Low Ron Load Switch

#### POWER MANAGEMENT -

#### **Features**

- Input Voltage Range 1.1V to 3.6V
- 2A Continuous Output Current
- Ultra-Low Ron 36mΩ
- Automatic Output Discharge Circuit
  - Fast Turn-on Option With No Output Discharge Circuit SC728
  - Extended Soft Start Option With Automatic Output Discharge Circuit – SC729
- Low Quiescent Current 0.81µA(Typ.)
- Low Shutdown Current < 1µA SC728
- 1.1V Logic Level Enable Compatible With CMOS/GPIO Control
- Hardened ESD Protection 3kV
- Package: CSP 0.76mm × 0.76mm, 0.4mm Pitch

## **Applications**

- Smart Phones
- Tablet PCs
- GPS Devices
- Battery Powered Equipment
- Other Portable Device

## **Description**

The SC728/SC729 is a low input voltage, very low Ron load switch designed for use in battery powered applications. Very low quiescent current of less than 2µA, and a low shutdown current of less than 1µA (SC728) reduces power loss during Standby and Off states. A logic level Enable allows low voltage on/off control down to 1.1V.

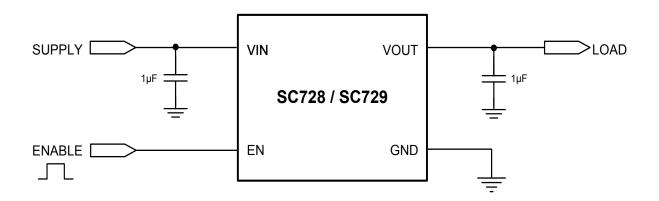
The SC728 provides a quick turn on time, while the SC729 provides a longer soft start to limit inrush current. The SC729 also features an automatic discharge circuit which discharges the output when the part is disabled.

The SC728/SC729 is offered in an ultra-small 4-bump 0.76mm  $\times$  0.76mm Chip Scale Package (CSP) which enables very small board area implementations. The SC728/SC729 has an operating ambient temperature range of -40°C to +85°C.

SC724/SC725 offers an alternative bump connection pattern to SC728/SC729. Please go to Semtech.com website for details.

Device	Package	Automatic Discharge	Rising Time
SC728	CSP	No	3µs(Typ.)
SC729	CSP	Yes	140µs(Typ.)

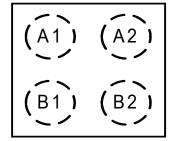
## **Typical Application Circuit**





# **Pin Configuration**





CSP 0.76x0.76, 4 Bump

## **Ordering Information**

Device	Package
SC728CSTRT	CSP 0.76mm×0.76mm 4-bump
SC729CSTRT	CSP 0.76mm×0.76mm 4-bump
SC728EVB	Evaluation Board
SC729EVB	Evaluation Board

#### Notes:

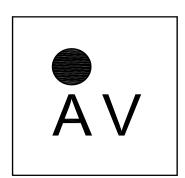
- (1) Available in tape and reel only. A reel contains 5,000 devices.
- (2) Lead-free packaging only. Device is WEEE and RoHS compliant, and halogen free.

## **Pin Descriptions**

Pin#	Pin Name	Pin Function
A2	VIN	Input Voltage.
B2	EN	Enable input. A $5.5M\Omega$ internal resistor is connected from this pin to GND. Drive HIGH to turn on the switch; drive LOW to turn off the switch. When the EN pin is floated, the switch is OFF.
A1	VOUT	Output Voltage.
B1	GND	Ground.



## **Marking Information(SC728)**

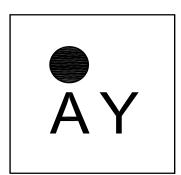


Marking for the 0.76 x 0.76 mm CSP 4 Lead Package:

O = Pin 1 ID

nn = Part No. Code (Example: AV) - Reference Part No.

## **Marking Information(SC729)**



Marking for the 0.76 x 0.76 mm CSP 4 Lead Package:

O = Pin 1 ID

nn = Part No. Code (Example: AY) - Reference Part No.



## **Absolute Maximum Ratings**

VIN to GND (V)0.3 to	+4.3
EN to GND (V)0.3 to	+4.3
OUT to GND (V)0.3 to	+V <sub>VIN</sub>
ESD Protection Level <sup>(1)</sup> (kV)	3

## **Recommended Operating Conditions**

Ambient Temperature Range (°C)40 $\leq$ $T_{_{\!A}} \leq$ +85
$V_{VIN}\left(V\right)$
Maximum Output Current (A)2

## **Thermal Information**

Thermal Resistance, Junction to Ambient <sup>(2)</sup> (°C	Z/W)160
$\label{thm:maximum Junction Temperature (°C)} Maximum Junction Temperature (°C)$	+125
Storage Temperature Range (°C)	-65 to +150
Peak IR Reflow Temperature (10s to 30s) (°C) .	+260

Exceeding the above specifications may result in permanent damage to the device or device malfunction. Operation outside of the parameters specified in the Electrical Characteristics section is not recommended.

#### NOTES:

- (1) Tested according to JEDEC standard JS-001-2012.
- (2) Calculated from package in still air, mounted to 3 x 4.5 (in), 4 layer FR4 PCB with thermal vias under the exposed pad per JESD51 standards.

### **Electrical Characteristics** —

Unless noted otherwise,  $T_A = 25^{\circ}\text{C}$  for typical,  $-40^{\circ}\text{C} < T_A = T_J < 85^{\circ}\text{C}$  for min and max.  $V_{VIN} = 1.8V$ ,  $C_{IN} = 1\mu\text{F}$ ,  $C_{OUT} = 1\mu\text{F}$ ,  $V_{EN} = V_{VIN}$ .

Parameter	Symbol	Conditions	Min	Тур	Max	Units	
On Resistance (Ron)		$V_{VIN} = 3.6V, I_{OUT} = 200 \text{mA}, V_{EN} = 1.5V$		24		mΩ	
		$V_{VIN} = 2.5V, I_{OUT} = 200 \text{mA}, V_{EN} = 1.5V$		29		mΩ	
	R <sub>on</sub>	V <sub>VIN</sub> =1.8V, I <sub>OUT</sub> =200mA, V <sub>EN</sub> =1.5V	= 200mA, V <sub>EN</sub> =1.5V 29 = 200mA, V <sub>EN</sub> =1.5V 36 = 200mA, V <sub>EN</sub> =1.5V 43 = 200mA, V <sub>EN</sub> =1.0V 57	36	47	mΩ	
		V <sub>VIN</sub> =1.5V, I <sub>OUT</sub> =200mA, V <sub>EN</sub> =1.5V			mΩ		
		V <sub>VIN</sub> =1.2V, I <sub>OUT</sub> =200mA, V <sub>EN</sub> =1.0V		57		mΩ	
Quiescent Current (1)	I <sub>Q</sub>	$V_{VIN} = V_{EN} = 3.6V, V_{OUT} = open$		0.81	2	μΑ	
Enable							
EN Input High Threshold	V <sub>EN-IH</sub>		1.1			V	
EN Input Low Threshold	V <sub>EN-IL</sub>				0.3	V	
EN Input Pull-Down Resistance	R <sub>EN</sub>			5.5		ΜΩ	
SC728							
Shutdown Current		V <sub>EN</sub> =0V, V <sub>OUT</sub> = open			1	μΑ	
Shutdown Current	SD	V <sub>EN</sub> =0V, V <sub>OUT</sub> = open, T <sub>A</sub> = 25°C			0.2	μΑ	



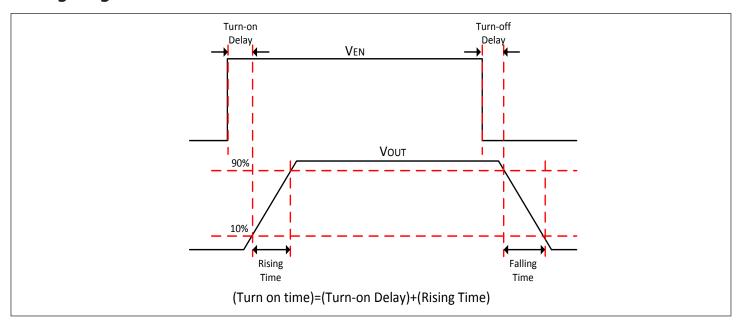
## **Electrical Characteristics (continued)**

Parameter	Symbol	Conditions	Min	Тур	Max	Units	
Turn or DeleviTime	Т <sub>рт</sub>	$V_{VIN} = 1.8V$ , $I_{OUT} = 200$ mA, $V_{EN} = 1.5V$ , $C_{OUT} = 1$ $\mu$ F		11		μs	
Turn-on Delay Time		$V_{VIN} = 3.6V, I_{OUT} = 200 \text{mA}, V_{EN} = 1.5V, C_{OUT} = 1 \mu F$		2.8		μs	
Diain a Time o		VIN 1 OUI 1 EN 1 OUI 1	8.5		μs		
Rising Time	T <sub>RT</sub>	$V_{VIN} = 3.6V, I_{OUT} = 200 \text{mA}, V_{EN} = 1.5V, C_{OUT} = 1 \mu F$		3		μs	
SC729							
Shatdaan Camart		V <sub>EN</sub> =0V, V <sub>OUT</sub> = open			8	μΑ	
Shutdown Current	SD	V <sub>EN</sub> =0V, V <sub>OUT</sub> = open, T <sub>A</sub> = 25°C			0.6	μΑ	
	Т <sub>рт</sub>	$V_{VIN} = 1.8V, I_{OUT} = 200 \text{mA}, V_{EN} = 1.5V, C_{OUT} = 1 \mu F$		240		μs	
Turn-on Delay Time		$V_{VIN} = 3.6V, I_{OUT} = 200 \text{mA}, V_{EN} = 1.5V, C_{OUT} = 1 \mu F$		110		μs	
Dising Time	_	$V_{VIN} = 1.8V, I_{OUT} = 200 \text{mA}, V_{EN} = 1.5V, C_{OUT} = 1 \mu F$		250		μs	
Rising Time	T <sub>RT</sub>		140		μs		
Output Pull-Down Resistance	R <sub>PD</sub>	V <sub>VIN</sub> =1.8V		250		Ω	

#### Notes:

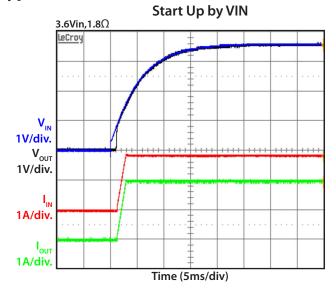
(1)  $I_Q$  current includes EN pull-down current.

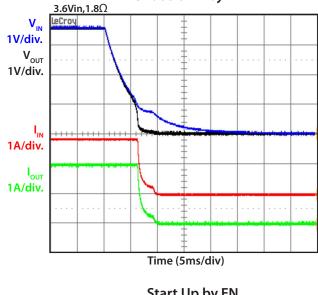
## **Timing Diagram**



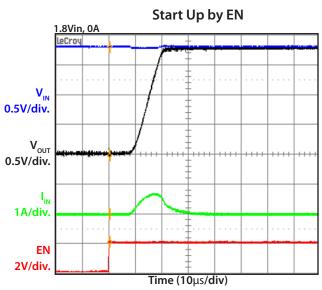


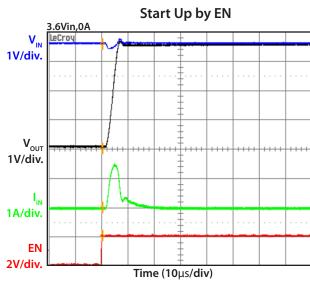
## **Typical Characteristics (SC728)**

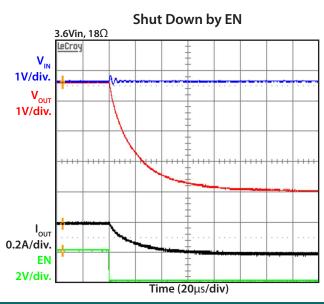




**Shut Down by VIN** 

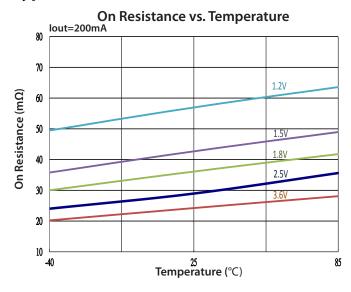


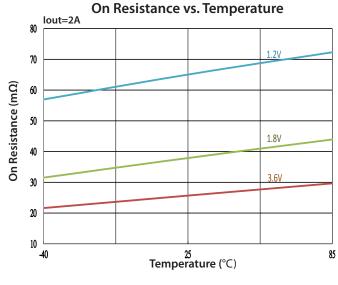


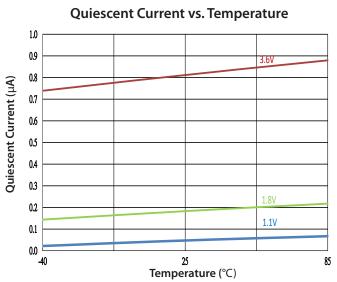


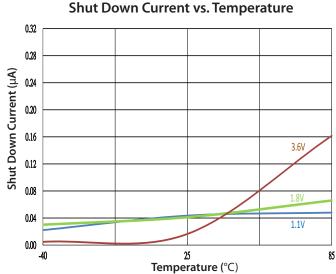


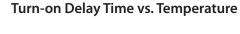
## Typical Characteristics (SC728), Cont.

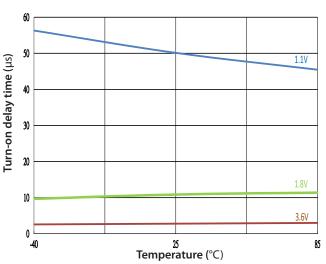


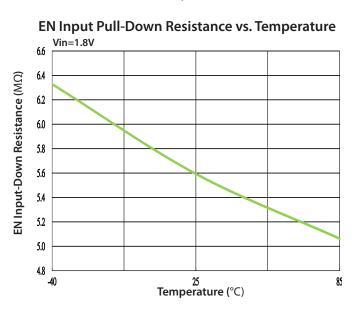






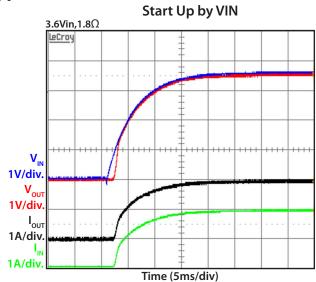


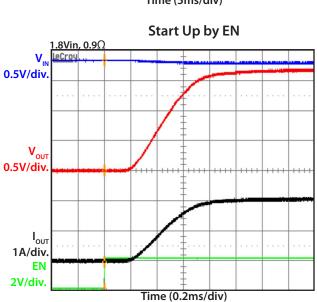


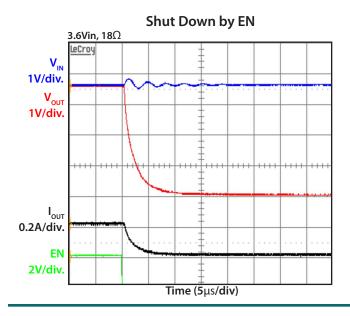


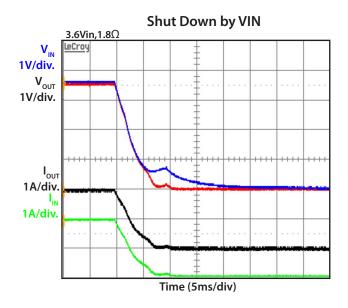


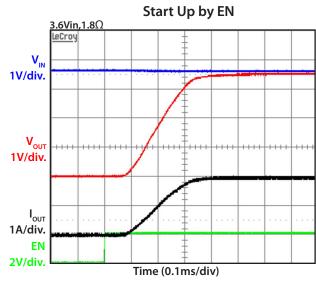
# **Typical Characteristics (SC729)**

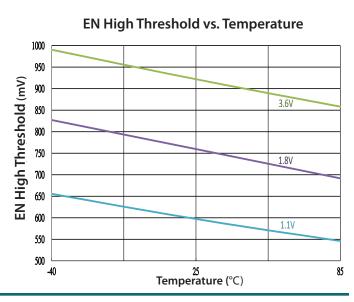








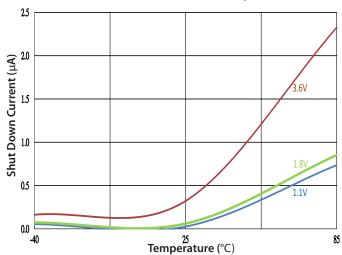


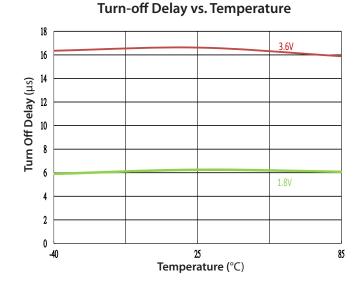




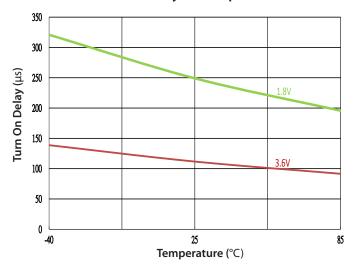
## Typical Characteristics (SC729), Cont.



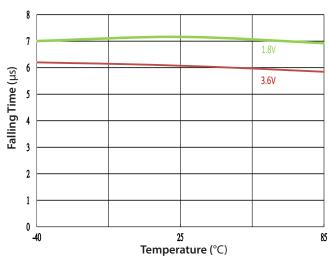




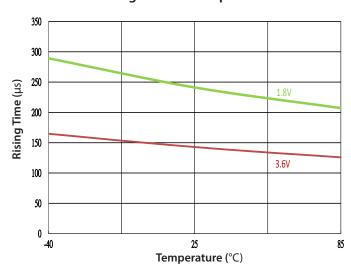
#### Turn-on Delay vs. Temperature



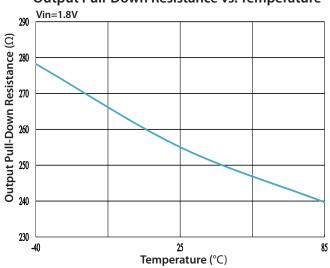
Falling Time vs. Temperature



#### **Rising Time vs. Temperature**



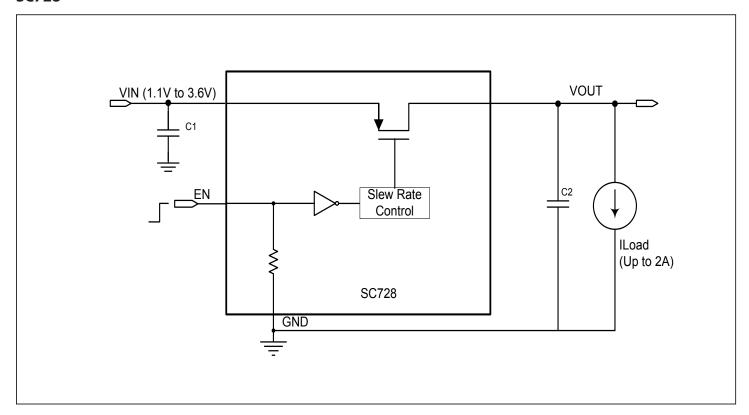
#### **Output Pull-Down Resistance vs. Temperature**



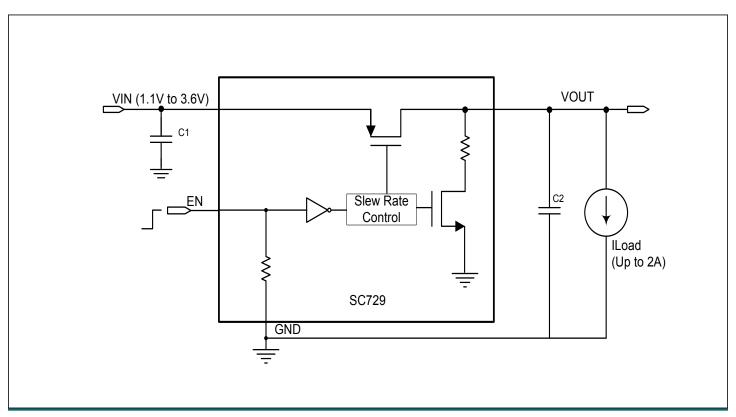


# **Block Diagram**

## **SC728**



### **SC729**





# Application Information Operation

The SC728/SC729 is an integrated high-side PMOS load switch that is designed to support up to 2A continuous output current and operate from an input voltage from 1.1V to 3.6V. The internal PMOS pass element has a very low ON resistance of 36m $\Omega$  (typical) at V<sub>IN</sub> = 1.8V. The SC728/SC729 also provides ultra-low shutdown and quiescent current for extended battery life during application off and standby states.

SC729 provides longer Turn-on Delay Time and Rising Time, which can help reduce inrush current and voltage drop on the input supply rail during power on.

SC728 provides shorter Turn-on Delay and Rising Time for applications where immediate response is required.

#### **Output Voltage Pull-down**

The SC729 also includes an automatic output discharge function. It employs a  $250\Omega$  (typical) discharge path to ground when the EN pin is disabled.

#### **Enable**

The EN pin controls the ON/OFF states of the load switch. Pulling the EN pin HIGH turns on the load switch. Pulling the EN pin LOW turns off the load switch. The EN pin incorporates a  $5.5 \text{M}\Omega$  (typical) pull-down resistor, so that when the EN pin is floating the SC728/SC279 is disabled.

#### **Input Capacitor**

In order to reduce the effects of voltage drop, noise, and bounce at the VIN pin, a filter/decoupling capacitor between VIN to GND is recommended. A 1µF ceramic capacitor is sufficient for most application conditions. However, it should be noted that suppressing bounce at input loop after EN is changed from HIGH to LOW can require greater capacitor values depending on particular designs. During certain shutdown conditions, as in the case when input power supply is abruptly removed, the input voltage may tend to drop faster than the output voltage. In this event a reverse current, through the body diode of internal PMOS FET, from VOUT to VIN can occur. To limit this reverse current, the Cin value should be selected greater than the Cout value.

#### **Output Capacitor**

A 1µF ceramic capacitor is normally used at the VOUT pin to suppress output noise and provide smooth voltage to the load. If a larger output capacitance value is used, the input inrush current should be considered because the power-on transient is also dependent on the output capacitor value. Note that SC729 has longer Turn-on Delay Time and Rising Time than SC728. If a larger output capacitor is used, SC729 could significantly improve input inrush current during power-on process.

#### **Board Layout Considerations**

Fig. 1 shows a typical application circuit with PCB inductance on the circuit board. An important objective of the layout is to minimize the PCB inductance by reducing the length and increasing the width of the traces. The input capacitor C1 and output capacitor C2 need to be placed close to the SC728/SC729. To analyze the stray inductance, Fig. 1 shows three current loops during the opening or closing of the load switch. The magnitude of the voltage ringing at VIN or VOUT pin is related to the PCB stray inductance and the placement of the capacitors. It is important to keep the voltage ringing below the maximum voltage rating of the SC728/SC729.

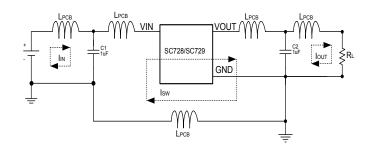


Figure 1 - PCB Circuit with Equivalent Parasitic Inductance

#### **Evaluation Board Information**

The Top Layer and Bottom Layer of a standard evaluation board are shown in Fig. 2 and Fig. 3, respectively.

Both T1 and T2 test points are Kelvin connections which can be used to minimize the measurement error of  $R_{ON}$ . To enable the part, a jumper can be used between VIN and EN on J1. To disable the part, a jumper can be connected between EN and GND on J1.



## **Top Layer**

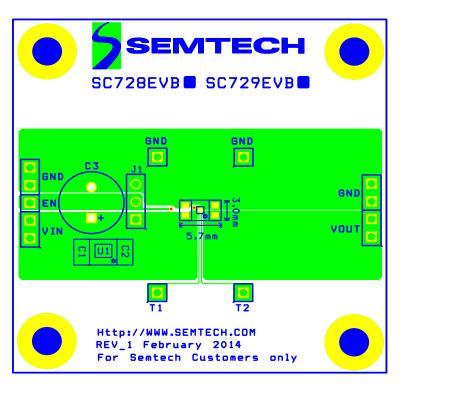
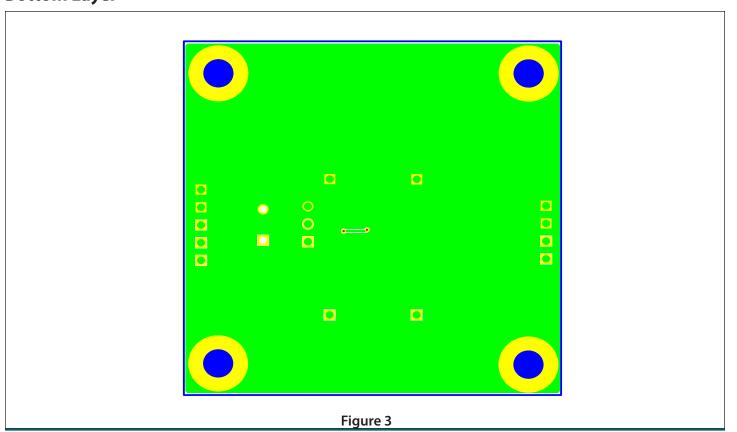


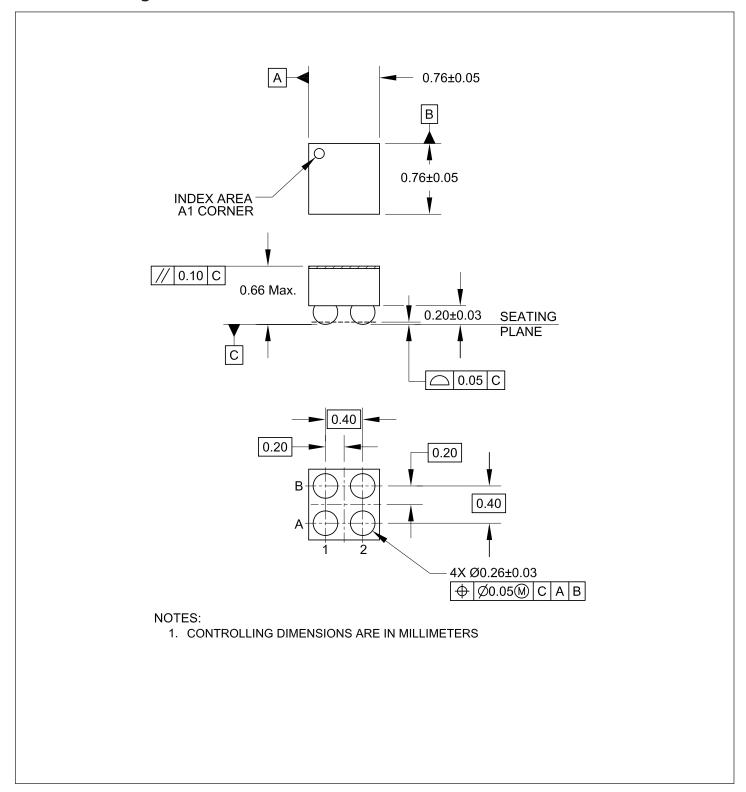
Figure 2

# **Bottom Layer**



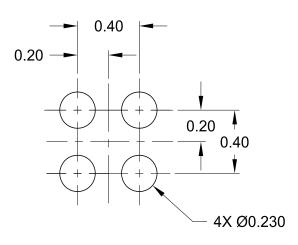


# Outline Drawing — CSP 0.76mm X 0.76mm, 4 Lead





## Land Pattern — CSP 0.76mm X 0.76mm, 4 Lead



#### NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.



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